

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YING-NAN CHAN	01/18/2016
SHU-CHEN HUANG	01/18/2016
CHIH-HAO LIN	01/18/2016
WEN-BIN CHEN	01/18/2016
KAI-CHI CHEN	01/18/2016
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15015818
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<b>ATTORNEY DOCKET NUMBER:</b>	0941-3344PUS1
<b>NAME OF SUBMITTER:</b>	ANALIZA STEPINA
<b>SIGNATURE:</b>	/analiza stepina/
<b>DATE SIGNED:</b>	02/05/2016
<b>Total Attachments: 2</b>	
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ASSIGNMENT

WHEREAS, Ying-Nan CHAN, Shu-Chen HUANG, Chih-Hao LIN, Wen-Bin CHEN and Kai-Chi CHEN hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Optical solid state prepolymer and molding composition

Filed: \_\_\_\_\_ Serial No. \_\_\_\_\_

Executed on: January 18, 2016

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 31040, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Ying-Nan CHAN	
Inventor's signature: <i>Ying-Nan CHAN</i>	Date: <i>2016. 1. 18</i>

Full name of second inventor: Shu-Chen HUANG	
Inventor's signature: <i>Shu-Chen HUANG</i>	Date: <i>2016. 1. 18</i>

Full name of third inventor: Chih-Hao LIN	
Inventor's signature: Chih-Hao LIN	Date: 2016.01.18

Full name of fourth inventor: Wen-Bin CHEN	
Inventor's signature: Wen-Bin Chen	Date: 2016.01.18

Full name of fifth inventor: Kai-Chi CHEN	
Inventor's signature: Kai-Chi Chen	Date: 2016.01.18

P54040025US; 0954-A24947-US